

Dimple Vijay Kochar

CONTACT INFORMATION

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EDUCATION

Massachusetts Institute of Technology *September, 2021 – Present*
PhD student, Department of Electrical Engineering & Computer Science
Advisor: Prof. Anantha Chandrakasan — MIT Energy-Efficient Circuits and Systems
GPA: 5.0 / 5.0

Indian Institute of Technology Bombay *July, 2016 – August, 2021*
Bachelor & Master of Technology, Department of Electrical Engineering
Specialization: Microelectronics & VLSI
Minor Degree, Department of Computer Science & Engineering
GPA: 9.34 / 10.0
Awarded the *Sharad Maloo Memorial Gold Medal* for being the second most outstanding student in terms of general proficiency, excellence in academic performance, extracurricular activities, and social services among all BTech/BTech+MTech students at the 59th Convocation of IIT Bombay

PUBLICATIONS

- **D. Kochar**, H. Wang, X. Zhang, A. Chandrakasan, “LEDRO: LLM-Enhanced Design Space Reduction and Optimization for Analog Circuits,” submitted to *IEEE Design, Automation and Test in Europe (DATE)*, 2025. **MIT**
- **D. Kochar**, M. Ashok, and A. Chandrakasan, “A 0.75mm² 407μW real-time speech audio denoiser with quantized cascaded redundant convolutional encoder-decoder for wearable IoT devices,” submitted to *International Conference on VLSI Design*, 2025. **MIT**
- S. Kim, C. Jung, **D. Kochar**, “Compute-in-Memory with Current Transition Detection,” U.S. App. No. 18/403,010, 2024. **Qualcomm**
- **D. Kochar**, T. Samadder, S. Mukhopadhyay and S. Mahapatra, “Modeling of HKMG Stack Process Impact on Gate Leakage, SILC and PBTI,” *IEEE International Reliability Physics Symposium (IRPS)*, 2021, pp. 1-7, doi: 10.1109/IRPS46558.2021.9405154. [\[paper\]](#) **IITB**
- **D. Kochar** and A. Kumar, “Estimation of Time to Failure Distribution in SRAM Due to Trapped Oxide Charges,” *IEEE International Symposium on Circuits and Systems (ISCAS)*, 2021, pp. 1-5, doi: 10.1109/ISCAS51556.2021.9401180. [\[paper\]](#) **IITB**
- T. Samadder, N. Choudhury, S. Kumar, **D. Kochar**, N. Parihar and S. Mahapatra, “A Physical Model for Bulk Gate Insulator Trap Generation During Bias-Temperature Stress in Differently Processed p-Channel FETs,” in *IEEE Transactions on Electron Devices*, vol. 68, no. 2, pp. 485-490, Feb. 2021, doi: 10.1109/TED.2020.3045960. [\[paper\]](#) **IITB**
- S. Kumar*, T. Samadder*, **D. Kochar**, and S. Mahapatra, “A Stochastic Simulation Framework for TDDB in MOS Gate Insulator Stacks” presented in *International Conference on Simulation of Semiconductor Processes and Devices (SISPAD)*, 2022. **IITB**

RESEARCH PROJECTS

Generative AI for Analog Circuit Sizing Optimization *MIT & MIT-IBM AI Watson Lab*
Advisor: Prof. Anantha Chandrakasan, EECS Department *Jan '24 - Present*

Introduction: Analog circuit design traditionally relies on human expertise, with Reinforcement Learning (RL) and Bayesian Optimization (BO) often requiring extensive time and numerous steps to navigate the large design space. We propose using Large Language Models (LLMs) to narrow the design space for analog circuit sizing, allowing even individuals without extensive circuit design knowledge to design. Our approach eliminates the need for design annotation or training.

- Offers broader generalizability across diverse circuits; adaptable to any optimization technique
- Delivers an average improvement in FoM of upto 20% in low-complexity and 55% in high-complexity op-amps over best baseline across technology nodes, average speed up of 1.6x
- One of the first to benchmarked across 22 amplifier topologies and four FinFET technology nodes

Low Power Speech Enhancement Chip for IoT Device

MIT

Advisor: Prof. Anantha Chandrakasan, EECS Department

Nov '22 - Present

Introduction: Audio denoising is crucial for delivering high-quality sound in applications ranging from communication devices to entertainment systems. Machine learning (ML) models exhibit strong audio processing performance in the frequency domain but require efficient hardware design. This work focuses on enhancing audio quality using convolutional encoder-decoder ML models with low power consumption while meeting real-time processing constraints.

- Fabricated in TSMC 28nm process, consumes 407 μ W or 3.24 μ J/frame with process time < 8ms
- Achieves the highest audio quality score (PESQ) of 2.79 across -6 to 9 dB SNR range on CHiME2
- Developed a quantized CNN; hardware quantization scheme reduces memory usage by up to 75%; complementary dataflow scheme reduces the on-chip memory accesses by 5-9x

HKMG Stack Process Impact on Gate Leakage, SILC & PBTI [slides]

IIT Bombay

Advisor: Prof. Souvik Mahapatra, Electrical Engineering Department

Dec '18 - Oct '20

Introduction: The primary impediment to channel length scaling is gate leakage. PBTI and SILC also get worse at scaled EOT. Recently, RD and RDD models are used for NBTI interface and bulk trap generation in PMOS. This project aims to model direct tunneling leakage, SILC & PBTI along with the traps generated in NMOS with deeply scaled (down to EOT \sim 7Å) HKMG stacks.

- Quantified impact of IL & HK thickness, channel/IL & IL/HK barriers on gate leakage & SILC
- Extracted bulk trap densities from SILC measurements of differently processed NMOS using a WKB tunneling model & used a Reaction-Diffusion-Drift (RDD) framework to model them
- Modelled the traps generated from PBTI stress using the double interface H/H₂ RD framework
- Analysed impact of gate stack process (pre-clean, IL, IL/HK interface, HK & post-HK nitridation) on gate leakage, SILC and PBTI trap generation (using DCIV) at IL/HK interface

Method for Time To Failure Estimation of SRAM due to RTN [slides]

IIT Bombay

Advisor: Prof. Animesh Kumar, Electrical Engineering Department

Dec '18 - Nov '20

Introduction: Trapping and detrapping of charges in the oxide interface of a MOSFET leads to a random telegraphic noise (RTN) injection & this phenomenon negatively affects the reliability of circuits. The objective of this project is to develop a reproducible strategy to obtain time to failure (TTF) distribution & related statistics for SRAM of any technology with any given RTN model.

- Proposed a method to estimate TTF distribution of a stored bit in an SRAM cell due to single or multi-level RTN by composition of Monte-Carlo simulations & circuit-level abstraction
- Showcased results of this procedure on an SRAM cell with a single-trap RTN model
- Indicated via circuit-level simulations that the TTF distribution worsens due to process variations

Model for Time Dependent Dielectric Breakdown for Thin Oxides [slides]

IIT Bombay

Advisor: Prof. Souvik Mahapatra, Electrical Engineering Department

May '18 - Jun '21

Introduction: Time-dependent dielectric breakdown (TDDB) is characterized by its Weibull slope. In this project, the change in the slope is explained by a percolation model with different defect generation rates in the bulk & channel/oxide and gate/oxide interfaces, also considering SILC slope changes with thickness & trap size. The model is then extended for high-k with interfacial SiO₂.

- Designed a cell based oxide percolation model which stochastically creates bulk & interface traps
- Procured time to failure distribution & analysed the relation of its Weibull slope with oxide thickness & obtained results obeying experimental data varying with voltage & temperature
- Proposed and demonstrated a hypothesis for differences in bulk trap & SILC slopes

RESEARCH
INTERNSHIPS

Making In-Memory Computing Reliable

Qualcomm

Memory IP Team, San Diego

Jun '23 - Aug '23

Introduction: A major percentage of today's deep learning architecture are the MAC operations. If the weights are stored in the foundry 8-T bit-cell, and the RWL has the input coming in, current proportional to the compute output passes through the RBL. Due to process variations, this current varies in a large range. Foundry bit-cell is essential to use SRAM design rules and ensure scalability. To solve this problem, two approaches were implemented in TSMC N3E technology node.

- Filed a patent app. for a robust against process variations technique for accurate IMC SRAM
- Developed a circuit + ML model for bit prediction with 96.4% accuracy in TSMC N3E 8T SRAM

Dipole-Exchange Spin Waves in Thin Ferromagnetic Films [slides]

Advisors: Prof. Gerrit Bauer, Kavli Institute of Nanoscience

Prof. Yaroslav Blanter, Kavli Institute of Nanoscience

TU Delft

May '19 - Jul '19

Introduction: Dispersion characteristics of spin waves in ferromagnetic films taking into account both the dipole-dipole and the exchange interactions are obtained by a sixth-order differential equation. The objective of this project is to solve it considering pinned and unpinned boundary conditions & study their variation with thickness in this transition region.

- Calculated the wave function, magnetization & dipolar field profiles for various modes of spin waves by solving Landau-Lifshitz & Maxwells' equations & appropriate boundary conditions
- Showed how chirality changes with thickness; obtained the dispersion relation (ω vs \vec{k}) for a film
- Obtained isofrequency curves & showed their change with increase in magnetic field in \vec{k} space

SCHOLASTIC ACHIEVEMENTS

- Conferred the 'Grass Instrument Company Fellowship' to support first year at MIT
- Bestowed the 'Desai-Sethi Scholarship' awarded to the top 5 girls admitted to IIT Bombay
- Achieved All India Rank 102 in JEE Main and All India Rank 295 in JEE Advanced out of 1.2 & 0.2 million candidates respectively; stood first in both in the state of Maharashtra among girls
- Awarded the 'Travel Grants for UG students by C'1992 and C'1998' for IEEE ISCAS 2021

TECHNICAL PROJECTS

Ring Oscillator Characterization

MIT-IBM AI Watson Lab

- Taped out in 14nm Samsung technology, designed for accurate power & frequency measurements

Low Power FC-CS CMOS Operational Amplifier

Analog Circuits

- Designed an FC-CS CMOS opamp in 22nm bsim4 with power < 1.5mW, settling times < 8ns, open loop gain > 10k, thermal noise < 300uV, phase margin > 65° at gain-of-2 frequency

Power Amplifier Design for function at 520 MHz

Solid State Microwave Devices

- Constructed matching networks using microstrip transmission lines and fabricated it on FR4 substrate to obtain a gain of 2.5 dB at 520 MHz with S_{11} and S_{12} values -18 dB and -35 dB

Sub-100nm Gate GaN HEMT transistor fabrication

Device Fabrication

- Fabricated a HEMT on GaN-on-Si with an $I_{ON} = 1.3A/mm$ and $R_{ON} = 1.54\Omega$ at MIT.nano

Broadband 4 × 4 Butler Matrix Circuit at 5.4GHz

Microwave Integrated Circuits

- Constructed 90° hybrids & phase delay lines using microstrip transmission lines to equally divide power, fabricated on FR4 substrate & achieved equal power division and input port isolation

Other projects:

- Implemented IITB-RISC on DE0-Nano FPGA, an 8-register, 16-bit system with 15 instructions in standard 6 stage pipelines & equipped it with control flow, data forwarding & hazard mitigation
- Awarded the best among 70+ projects for implementing an audio volume controller, motion tracker & a pattern lock by gesture detection using infrared emitters & sensors and CPLD
- Stood in the top 5 teams in the Make in India presentation organised for TEQIP-III for heart rate variability analysis by processing the ECG signal & PSD to predict risk of myocardial infarction

TEACHING & MENTORING EXPERIENCE

Teaching Assistant for MIT Course

6.6000 (6.775): CMOS Analog and Circuit Design, Spring '24

Teaching Assistant for IIT Bombay Courses

EE302: Control Systems, Spring '21

EE325: Probability & Random Processes, Fall '20

MA108: Differential Equations, Spring '18

PH107: Quantum Mechanics, Fall '17

Mentor, Graduate Application Assistance Program, EECS, MIT 2023

Mentor, Department Academic Mentorship Program, IIT Bombay 2019-2021

LEADERSHIP IN JOURNALISM

Recipient of the Institute Journalism Special Mention Award at IIT Bombay

Editor, Insight, IIT Bombay

Apr '18 - Mar '19

Official Print Media Body | Circulated to 10K+ students & 650+ faculty | Online readership 0.4M+

Convener, IIT Bombay Broadcasting Channel

Apr '17 - Mar '18

Official Multimedia Journalism Body | 50K+ YouTube Subscribers | 25K+ Facebook Followers